

Features

- Ideal for surface mount applications
- Easy pick and place
- Built-in strain relief
- Fast switching speed



SMB

Mechanical Data

Case: Molded plastic

Epoxy: UL 94V-0 rate flame retardantMetallurgically bonded construction

Polarity: Color band denotes cathode end

Mounting position: AnyWeight: 0.093 grams

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)			
US3A-US3M	SMB	HXY MOSFET	3000			

Maximum Ratings And Electrical Characteristics

Rating 25°C ambient temperature uniess otherwies specified. Single phase half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Type Number	US3A	US3B	US3D	US3E	US3G	US3J	US3K	US3M	Unit
Maximum Recurrent Peak Reverse Voltage		100	200	300	400	600	800	1000	V
Maximum RMS Voltage		70	140	210	280	420	560	700	V
Maximum DC Blocking Voltage		100	200	300	400	600	800	1000	V
Maximum Average Forward Rectified Current									
at Ta=55°C	3.0							Α	
Peak Forward Surge Current, 8.3 ms single half sine-wave									
superimposed on rated load (JEDEC method)		100							Α
Maximum Instantaneous Forward Voltage at 3.0A		1.0		1.3		1.85			V
Maximum DC Reverse Current Ta=25°C		10							μА
at Rated DC Blocking Voltage Ta=100°C	200				μА				
Maximum Reverse Recovery Time (Note 1)		50				75		nS	
Typical Junction Capacitance (Note 2)		75							pF
Operating and Storage Temperature Range TJ, Tstg		-65 — +150							°C

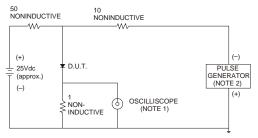
NOTES:

- 1. Reverse Recovery Time test condition: IF=0.5A, IR=1.0A, IRR=0.25A
- 2. Measured at 1MHz and applied reverse voltage of 4.0V D.C.



Typical Characteristics

FIG.3- TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTICS



NOTES: 1. Rise Time= 7ns max., Input Impedance= 1 megohm.22pF.

2. Rise Time= 10ns max., Source Impedance= 50 ohms.

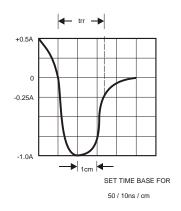


FIG.2-TYPICAL FORWARD CURRENT DERATING CURVE

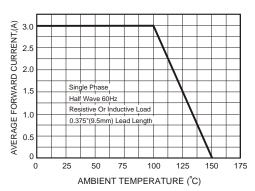


FIG.4-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

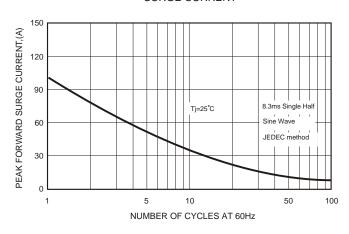
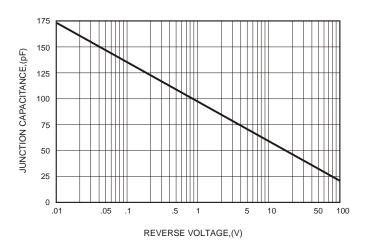
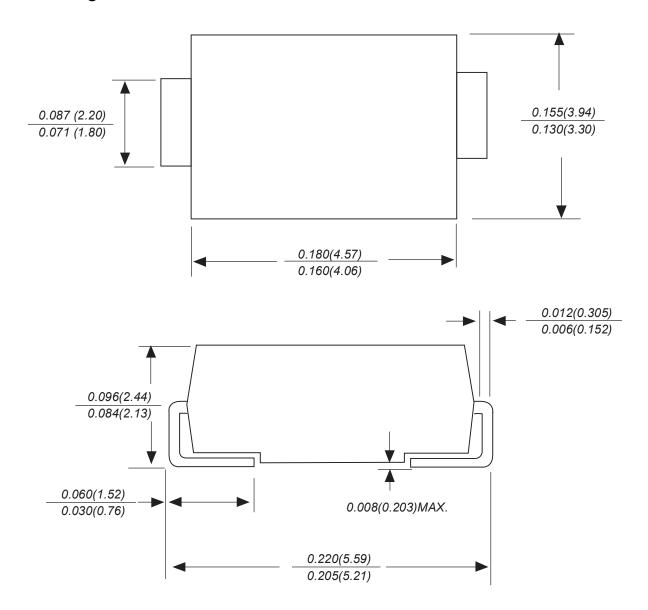


FIG.5-TYPICAL JUNCTION CAPACITANCE





SMB Package Outline Dimensions



Dimensions in inches and (millimeters)



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